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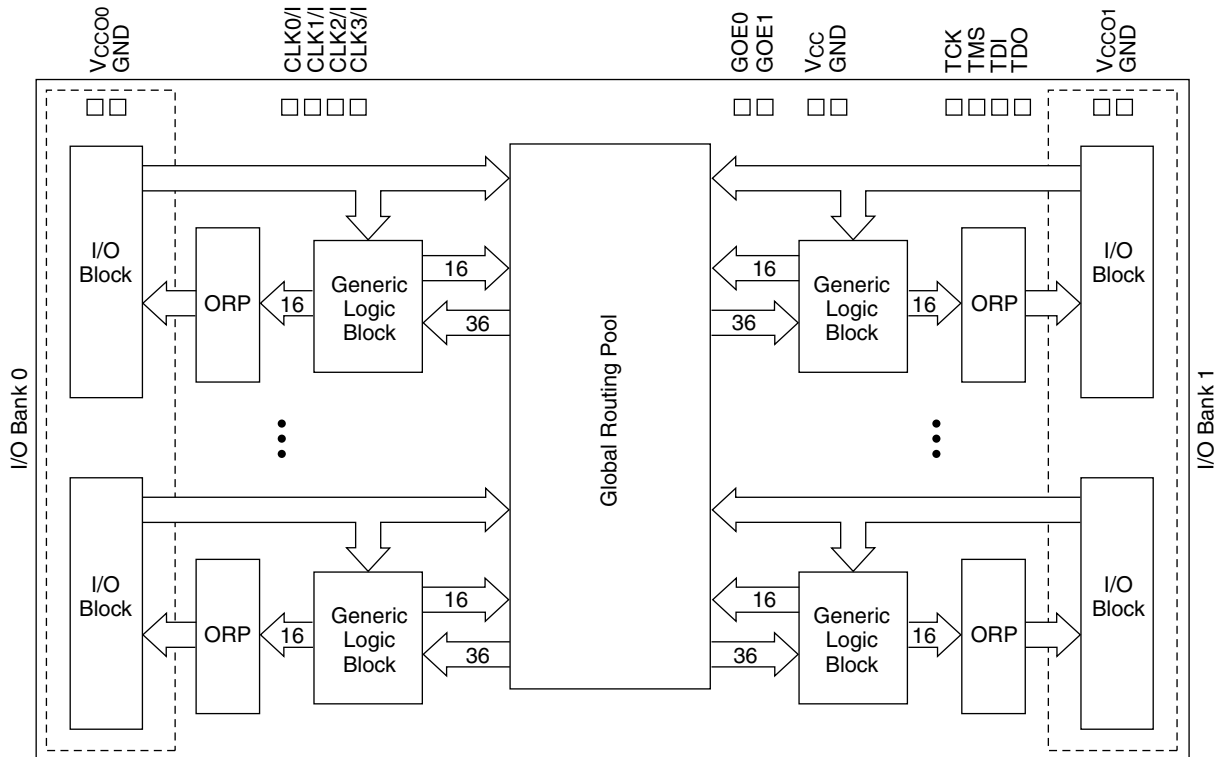
Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

| | |
|---------------------------------|---|
| Product Status | Obsolete |
| Programmable Type | In System Programmable |
| Delay Time tpd(1) Max | 5 ns |
| Voltage Supply - Internal | 1.7V ~ 1.9V |
| Number of Logic Elements/Blocks | 4 |
| Number of Macrocells | 64 |
| Number of Gates | - |
| Number of I/O | 64 |
| Operating Temperature | 0°C ~ 90°C (TJ) |
| Mounting Type | Surface Mount |
| Package / Case | 132-LFBGA, CSPBGA |
| Supplier Device Package | 132-CSBGA (8x8) |
| Purchase URL | https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4064zc-5m132c |

Figure 1. Functional Block Diagram

The I/Os in the ispMACH 4000 are split into two banks. Each bank has a separate I/O power supply. Inputs can support a variety of standards independent of the chip or bank power supply. Outputs support the standards compatible with the power supply provided to the bank. Support for a variety of standards helps designers implement designs in mixed voltage environments. In addition, 5V tolerant inputs are specified within an I/O bank that is connected to V_{CC0} of 3.0V to 3.6V for LVCMOS 3.3, LVTTTL and PCI interfaces.

ispMACH 4000 Architecture

There are a total of two GLBs in the ispMACH 4032, increasing to 32 GLBs in the ispMACH 4512. Each GLB has 36 inputs. All GLB inputs come from the GRP and all outputs from the GLB are brought back into the GRP to be connected to the inputs of any other GLB on the device. Even if feedback signals return to the same GLB, they still must go through the GRP. This mechanism ensures that GLBs communicate with each other with consistent and predictable delays. The outputs from the GLB are also sent to the ORP. The ORP then sends them to the associated I/O cells in the I/O block.

Generic Logic Block

The ispMACH 4000 GLB consists of a programmable AND array, logic allocator, 16 macrocells and a GLB clock generator. Macrocells are decoupled from the product terms through the logic allocator and the I/O pins are decoupled from macrocells through the ORP. Figure 2 illustrates the GLB.

Product Term Allocator

The product term allocator assigns product terms from a cluster to either logic or control applications as required by the design being implemented. Product terms that are used as logic are steered into a 5-input OR gate associated with the cluster. Product terms that used for control are steered either to the macrocell or I/O cell associated with the cluster. Table 3 shows the available functions for each of the five product terms in the cluster. The OR gate output connects to the associated I/O cell, providing a fast path for narrow combinatorial functions, and to the logic allocator.

Table 3. Individual PT Steering

| Product Term | Logic | Control |
|--------------|----------|---|
| PT n | Logic PT | Single PT for XOR/OR |
| PT $n+1$ | Logic PT | Individual Clock (PT Clock) |
| PT $n+2$ | Logic PT | Individual Initialization or Individual Clock Enable (PT Initialization/CE) |
| PT $n+3$ | Logic PT | Individual Initialization (PT Initialization) |
| PT $n+4$ | Logic PT | Individual OE (PTOE) |

Cluster Allocator

The cluster allocator allows clusters to be steered to neighboring macrocells, thus allowing the creation of functions with more product terms. Table 4 shows which clusters can be steered to which macrocells. Used in this manner, the cluster allocator can be used to form functions of up to 20 product terms. Additionally, the cluster allocator accepts inputs from the wide steering logic. Using these inputs, functions up to 80 product terms can be created.

Table 4. Available Clusters for Each Macrocell

| Macrocell | Available Clusters | | | |
|-----------|--------------------|-----|-----|-----|
| M0 | — | C0 | C1 | C2 |
| M1 | C0 | C1 | C2 | C3 |
| M2 | C1 | C2 | C3 | C4 |
| M3 | C2 | C3 | C4 | C5 |
| M4 | C3 | C4 | C5 | C6 |
| M5 | C4 | C5 | C6 | C7 |
| M6 | C5 | C6 | C7 | C8 |
| M7 | C6 | C7 | C8 | C9 |
| M8 | C7 | C8 | C9 | C10 |
| M9 | C8 | C9 | C10 | C11 |
| M10 | C9 | C10 | C11 | C12 |
| M11 | C10 | C11 | C12 | C13 |
| M12 | C11 | C12 | C13 | C14 |
| M13 | C12 | C13 | C14 | C15 |
| M14 | C13 | C14 | C15 | — |
| M15 | C14 | C15 | — | — |

Wide Steering Logic

The wide steering logic allows the output of the cluster allocator n to be connected to the input of the cluster allocator $n+4$. Thus, cluster chains can be formed with up to 80 product terms, supporting wide product term functions and allowing performance to be increased through a single GLB implementation. Table 5 shows the product term chains.

IEEE 1532-Compliant In-System Programming

Programming devices in-system provides a number of significant benefits including: rapid prototyping, lower inventory levels, higher quality and the ability to make in-field modifications. All ispMACH 4000 devices provide In-System Programming (ISP™) capability through the Boundary Scan Test Access Port. This capability has been implemented in a manner that ensures that the port remains compliant to the IEEE 1149.1 standard. By using IEEE 1149.1 as the communication interface through which ISP is achieved, users get the benefit of a standard, well-defined interface. All ispMACH 4000 devices are also compliant with the IEEE 1532 standard.

The ispMACH 4000 devices can be programmed across the commercial temperature and voltage range. The PC-based Lattice software facilitates in-system programming of ispMACH 4000 devices. The software takes the JEDEC file output produced by the design implementation software, along with information about the scan chain, and creates a set of vectors used to drive the scan chain. The software can use these vectors to drive a scan chain via the parallel port of a PC. Alternatively, the software can output files in formats understood by common automated test equipment. This equipment can then be used to program ispMACH 4000 devices during the testing of a circuit board.

User Electronic Signature

The User Electronic Signature (UES) allows the designer to include identification bits or serial numbers inside the device, stored in E²CMOS memory. The ispMACH 4000 device contains 32 UES bits that can be configured by the user to store unique data such as ID codes, revision numbers or inventory control codes.

Security Bit

A programmable security bit is provided on the ispMACH 4000 devices as a deterrent to unauthorized copying of the array configuration patterns. Once programmed, this bit defeats readback of the programmed pattern by a device programmer, securing proprietary designs from competitors. Programming and verification are also defeated by the security bit. The bit can only be reset by erasing the entire device.

Hot Socketing

The ispMACH 4000 devices are well-suited for applications that require hot socketing capability. Hot socketing a device requires that the device, during power-up and down, can tolerate active signals on the I/Os and inputs without being damaged. Additionally, it requires that the effects of I/O pin loading be minimal on active signals. The ispMACH 4000 devices provide this capability for input voltages in the range 0V to 3.0V.

Density Migration

The ispMACH 4000 family has been designed to ensure that different density devices in the same package have the same pin-out. Furthermore, the architecture ensures a high success rate when performing design migration from lower density parts to higher density parts. In many cases, it is possible to shift a lower utilization design targeted for a high density device to a lower density device. However, the exact details of the final resource utilization will impact the likely success in each case.

I/O Recommended Operating Conditions

| Standard | V_{CCO} (V) ¹ | |
|-----------------------------------|----------------------------|------|
| | Min. | Max. |
| LVTTL | 3.0 | 3.6 |
| LVC MOS 3.3 | 3.0 | 3.6 |
| Extended LVC MOS 3.3 ² | 2.7 | 3.6 |
| LVC MOS 2.5 | 2.3 | 2.7 |
| LVC MOS 1.8 | 1.65 | 1.95 |
| PCI 3.3 | 3.0 | 3.6 |

1. Typical values for V_{CCO} are the average of the min. and max. values.

2. ispMACH 4000Z only.

DC Electrical Characteristics

Over Recommended Operating Conditions

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Units |
|------------------------|---|---|------------------|------|------------------|---------|
| $I_{IL}, I_{IH}^{1,4}$ | Input Leakage Current (ispMACH 4000Z) | $0 \leq V_{IN} < V_{CCO}$ | — | 0.5 | 1 | μA |
| I_{IH}^1 | Input High Leakage Current (ispMACH 4000Z) | $V_{CCO} < V_{IN} \leq 5.5V$ | — | — | 10 | μA |
| I_{IL}, I_{IH}^1 | Input Leakage Current (ispMACH 4000V/B/C) | $0 \leq V_{IN} \leq 3.6V, T_j = 105^\circ C$ | — | — | 10 | μA |
| | | $0 \leq V_{IN} \leq 3.6V, T_j = 130^\circ C$ | — | — | 15 | μA |
| $I_{IH}^{1,2}$ | Input High Leakage Current (ispMACH 4000V/B/C) | $3.6V < V_{IN} \leq 5.5V, T_j = 105^\circ C$ $3.0V \leq V_{CCO} \leq 3.6V$ | — | — | 20 | μA |
| | | $3.6V < V_{IN} \leq 5.5V, T_j = 130^\circ C$ $3.0V \leq V_{CCO} \leq 3.6V$ | — | — | 50 | μA |
| I_{PU} | I/O Weak Pull-up Resistor Current (ispMACH 4000Z) | $0 \leq V_{IN} \leq 0.7V_{CCO}$ | -30 | — | -150 | μA |
| | I/O Weak Pull-up Resistor Current (ispMACH 4000V/B/C) | $0 \leq V_{IN} \leq 0.7V_{CCO}$ | -30 | — | -200 | μA |
| I_{PD} | I/O Weak Pull-down Resistor Current | $V_{IL} (MAX) \leq V_{IN} \leq V_{IH} (MIN)$ | 30 | — | 150 | μA |
| I_{BHLS} | Bus Hold Low Sustaining Current | $V_{IN} = V_{IL} (MAX)$ | 30 | — | — | μA |
| I_{BHHS} | Bus Hold High Sustaining Current | $V_{IN} = 0.7 V_{CCO}$ | -30 | — | — | μA |
| I_{BHLO} | Bus Hold Low Overdrive Current | $0V \leq V_{IN} \leq V_{BHT}$ | — | — | 150 | μA |
| I_{BHHO} | Bus Hold High Overdrive Current | $V_{BHT} \leq V_{IN} \leq V_{CCO}$ | — | — | -150 | μA |
| V_{BHT} | Bus Hold Trip Points | — | $V_{CCO} * 0.35$ | — | $V_{CCO} * 0.65$ | V |
| C_1 | I/O Capacitance ³ | $V_{CCO} = 3.3V, 2.5V, 1.8V$ | — | 8 | — | pf |
| | | $V_{CC} = 1.8V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$ | — | | — | |
| C_2 | Clock Capacitance ³ | $V_{CCO} = 3.3V, 2.5V, 1.8V$ | — | 6 | — | pf |
| | | $V_{CC} = 1.8V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$ | — | | — | |
| C_3 | Global Input Capacitance ³ | $V_{CCO} = 3.3V, 2.5V, 1.8V$ | — | 6 | — | pf |
| | | $V_{CC} = 1.8V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$ | — | | — | |

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tristated. It is not measured with the output driver active. Bus maintenance circuits are disabled.

2. 5V tolerant inputs and I/O should only be placed in banks where $3.0V \leq V_{CCO} \leq 3.6V$.

3. $T_A = 25^\circ C$, $f = 1.0MHz$

4. I_{IH} excursions of up to 1.5 μA maximum per pin above the spec limit may be observed for certain voltage conditions on no more than 10% of the device's I/O pins.

Supply Current, ispMACH 4000Z (Cont.)

Over Recommended Operating Conditions

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Units |
|---------------------------|--------------------------------|--|------|------|------|-------|
| ispMACH 4256ZC | | | | | | |
| ICC ^{1, 2, 3, 5} | Operating Power Supply Current | V _{CC} = 1.8V, T _A = 25°C | — | 341 | — | μA |
| | | V _{CC} = 1.9V, T _A = 70°C | — | 361 | — | μA |
| | | V _{CC} = 1.9V, T _A = 85°C | — | 372 | — | μA |
| | | V _{CC} = 1.9V, T _A = 125°C | — | 468 | — | μA |
| ICC ^{4, 5} | Standby Power Supply Current | V _{CC} = 1.8V, T _A = 25°C | — | 13 | — | μA |
| | | V _{CC} = 1.9V, T _A = 70°C | — | 32 | 55 | μA |
| | | V _{CC} = 1.9V, T _A = 85°C | — | 43 | 90 | μA |
| | | V _{CC} = 1.9V, T _A = 125°C | — | 135 | — | μA |

1. T_A = 25°C, frequency = 1.0 MHz.

2. Device configured with 16-bit counters.

3. I_{CC} varies with specific device configuration and operating frequency.

4. V_{CCO} = 3.6V, V_{IN} = 0V or V_{CCO}, bus maintenance turned off. V_{IN} above V_{CCO} will add transient current above the specified standby I_{CC}.

5. Includes V_{CCO} current without output loading.

I/O DC Electrical Characteristics

Over Recommended Operating Conditions

| Standard | V_{IL} | | V_{IH} | | V_{OL} Max (V) | V_{OH} Min (V) | I_{OL}^1 (mA) | I_{OH}^1 (mA) |
|-------------------------|----------|------------------------------|------------------------------|---------|---------------------|---------------------|--------------------|--------------------|
| | Min (V) | Max (V) | Min (V) | Max (V) | | | | |
| LVTTTL | -0.3 | 0.80 | 2.0 | 5.5 | 0.40 | $V_{CCO} - 0.40$ | 8.0 | -4.0 |
| | | | | | 0.20 | $V_{CCO} - 0.20$ | 0.1 | -0.1 |
| LVCMOS 3.3 | -0.3 | 0.80 | 2.0 | 5.5 | 0.40 | $V_{CCO} - 0.40$ | 8.0 | -4.0 |
| | | | | | 0.20 | $V_{CCO} - 0.20$ | 0.1 | -0.1 |
| LVCMOS 2.5 | -0.3 | 0.70 | 1.70 | 3.6 | 0.40 | $V_{CCO} - 0.40$ | 8.0 | -4.0 |
| | | | | | 0.20 | $V_{CCO} - 0.20$ | 0.1 | -0.1 |
| LVCMOS 1.8 (4000V/B) | -0.3 | 0.63 | 1.17 | 3.6 | 0.40 | $V_{CCO} - 0.45$ | 2.0 | -2.0 |
| | | | | | 0.20 | $V_{CCO} - 0.20$ | 0.1 | -0.1 |
| LVCMOS 1.8 (4000C/Z) | -0.3 | $0.35 * V_{CC}$ | $0.65 * V_{CC}$ | 3.6 | 0.40 | $V_{CCO} - 0.45$ | 2.0 | -2.0 |
| | | | | | 0.20 | $V_{CCO} - 0.20$ | 0.1 | -0.1 |
| PCI 3.3 (4000V/B) | -0.3 | 1.08 | 1.5 | 5.5 | $0.1 V_{CCO}$ | $0.9 V_{CCO}$ | 1.5 | -0.5 |
| PCI 3.3 (4000C/Z) | -0.3 | $0.3 * 3.3 * (V_{CC} / 1.8)$ | $0.5 * 3.3 * (V_{CC} / 1.8)$ | 5.5 | $0.1 V_{CCO}$ | $0.9 V_{CCO}$ | 1.5 | -0.5 |

1. The average DC current drawn by I/Os between adjacent bank GND connections, or between the last GND in an I/O bank and the end of the I/O bank, as shown in the logic signals connection table, shall not exceed $n * 8\text{mA}$. Where n is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank.

ispMACH 4000V/B/C External Switching Characteristics

Over Recommended Operating Conditions

| Parameter | Description ^{1, 2, 3} | -25 | | -27 | | -3 | | -35 | | Units |
|-------------------------------|--|------|------|------|------|------|------|------|------|-------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | |
| t _{PD} | 5-PT bypass combinatorial propagation delay | — | 2.5 | — | 2.7 | — | 3.0 | — | 3.5 | ns |
| t _{PD_MC} | 20-PT combinatorial propagation delay through macrocell | — | 3.2 | — | 3.5 | — | 3.8 | — | 4.2 | ns |
| t _S | GLB register setup time before clock | 1.8 | — | 1.8 | — | 2.0 | — | 2.0 | — | ns |
| t _{ST} | GLB register setup time before clock with T-type register | 2.0 | — | 2.0 | — | 2.2 | — | 2.2 | — | ns |
| t _{SIR} | GLB register setup time before clock, input register path | 0.7 | — | 1.0 | — | 1.0 | — | 1.0 | — | ns |
| t _{SIRZ} | GLB register setup time before clock with zero hold | 1.7 | — | 2.0 | — | 2.0 | — | 2.0 | — | ns |
| t _H | GLB register hold time after clock | 0.0 | — | 0.0 | — | 0.0 | — | 0.0 | — | ns |
| t _{HT} | GLB register hold time after clock with T-type register | 0.0 | — | 0.0 | — | 0.0 | — | 0.0 | — | ns |
| t _{HIR} | GLB register hold time after clock, input register path | 0.9 | — | 1.0 | — | 1.0 | — | 1.0 | — | ns |
| t _{HIRZ} | GLB register hold time after clock, input register path with zero hold | 0.0 | — | 0.0 | — | 0.0 | — | 0.0 | — | ns |
| t _{CO} | GLB register clock-to-output delay | — | 2.2 | — | 2.7 | — | 2.7 | — | 2.7 | ns |
| t _R | External reset pin to output delay | — | 3.5 | — | 4.0 | — | 4.4 | — | 4.5 | ns |
| t _{RW} | External reset pulse duration | 1.5 | — | 1.5 | — | 1.5 | — | 1.5 | - | ns |
| t _{PTOE/DIS} | Input to output local product term output enable/disable | — | 4.0 | — | 4.5 | — | 5.0 | — | 5.5 | ns |
| t _{GPTOE/DIS} | Input to output global product term output enable/disable | — | 5.0 | — | 6.5 | — | 8.0 | — | 8.0 | ns |
| t _{GOE/DIS} | Global OE input to output enable/disable | — | 3.0 | — | 3.5 | — | 4.0 | — | 4.5 | ns |
| t _{CW} | Global clock width, high or low | 1.1 | — | 1.3 | — | 1.3 | — | 1.3 | — | ns |
| t _{GW} | Global gate width low (for low transparent) or high (for high transparent) | 1.1 | — | 1.3 | — | 1.3 | — | 1.3 | — | ns |
| t _{WIR} | Input register clock width, high or low | 1.1 | — | 1.3 | — | 1.3 | — | 1.3 | — | ns |
| f _{MAX} ⁴ | Clock frequency with internal feedback | — | 400 | — | 333 | — | 322 | — | 322 | MHz |
| f _{MAX} (Ext.) | Clock frequency with external feedback, [1/ (t _S + t _{CO})] | — | 250 | — | 222 | — | 212 | — | 212 | MHz |

1. Timing numbers are based on default LVCMOS 1.8 I/O buffers. Use timing adjusters provided to calculate other standards.

Timing v.3.2

2. Measured using standard switching circuit, assuming GRP loading of 1 and 1 output switching.

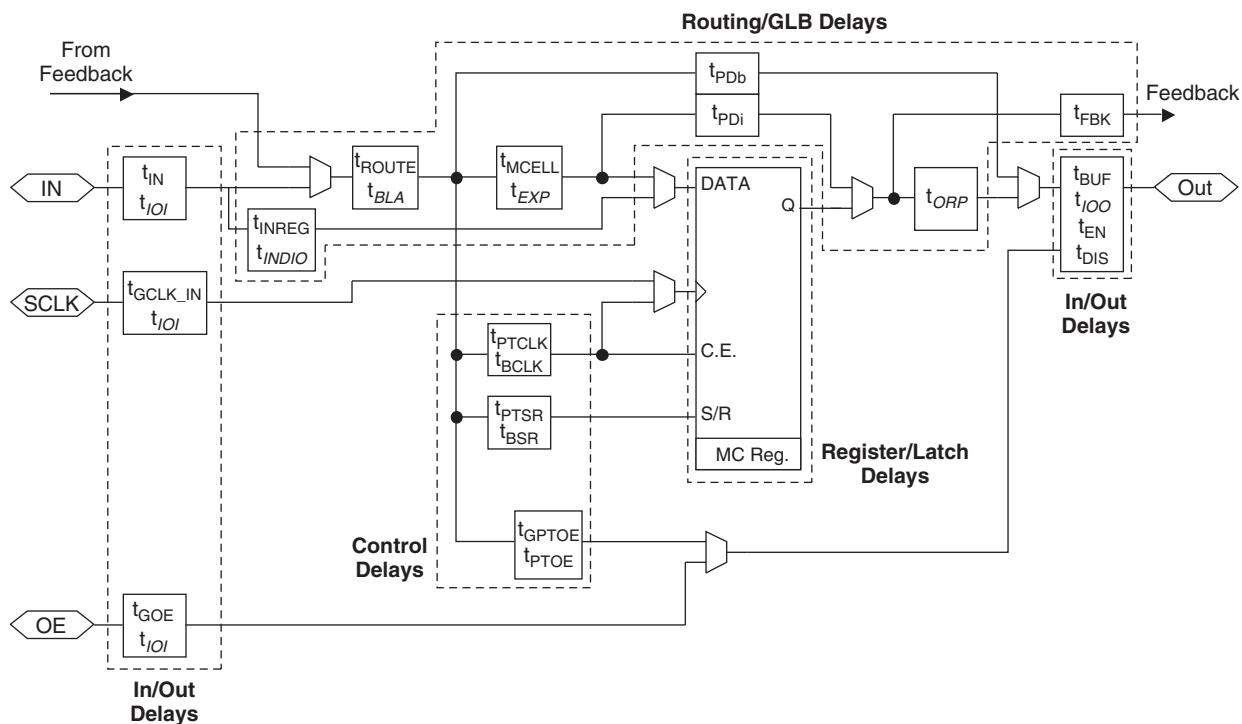
3. Pulse widths and clock widths less than minimum will cause unknown behavior.

4. Standard 16-bit counter using GRP feedback.

Timing Model

The task of determining the timing through the ispMACH 4000 family, like any CPLD, is relatively simple. The timing model provided in Figure 11 shows the specific delay paths. Once the implementation of a given function is determined either conceptually or from the software report file, the delay path of the function can easily be determined from the timing model. The Lattice design tools report the timing delays based on the same timing model for a particular design. Note that the internal timing parameters are given for reference only, and are not tested. The external timing parameters are tested and guaranteed for every device. For more information on the timing model and usage, refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#).

Figure 11. ispMACH 4000 Timing Model



Note: Italicized items are optional delay adders.

ispMACH 4000V/B/C Internal Timing Parameters (Cont.)**Over Recommended Operating Conditions**

| Parameter | Description | -5 | | -75 | | -10 | | Units |
|--------------------|-----------------------|------|------|------|------|------|------|-------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | |
| t _{GPTOE} | Global PT OE Delay | — | 5.58 | — | 5.58 | — | 5.78 | ns |
| t _{PTOE} | Macrocell PT OE Delay | — | 3.58 | — | 4.28 | — | 4.28 | ns |

Timing v.3.2

Note: Internal Timing Parameters are not tested and are for reference only. Refer to the Timing Model in this data sheet for further details.

**ispMACH 4032V/B/C and 4064V/B/C Logic Signal Connections:
44-Pin TQFP**

| Pin Number | Bank Number | ispMACH 4032V/B/C | | ispMACH 4064V/B/C | |
|------------|-------------|-------------------|-----------------|-------------------|----------------|
| | | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP |
| 1 | - | TDI | - | TDI | - |
| 2 | 0 | A5 | A ⁵ | A10 | A ⁵ |
| 3 | 0 | A6 | A ⁶ | A12 | A ⁶ |
| 4 | 0 | A7 | A ⁷ | A14 | A ⁷ |
| 5 | 0 | GND (Bank 0) | - | GND (Bank 0) | - |
| 6 | 0 | VCCO (Bank 0) | - | VCCO (Bank 0) | - |
| 7 | 0 | A8 | A ⁸ | B0 | B ⁰ |
| 8 | 0 | A9 | A ⁹ | B2 | B ¹ |
| 9 | 0 | A10 | A ¹⁰ | B4 | B ² |
| 10 | - | TCK | - | TCK | - |
| 11 | - | VCC | - | VCC | - |
| 12 | - | GND | - | GND | - |
| 13 | 0 | A12 | A ¹² | B8 | B ⁴ |
| 14 | 0 | A13 | A ¹³ | B10 | B ⁵ |
| 15 | 0 | A14 | A ¹⁴ | B12 | B ⁶ |
| 16 | 0 | A15 | A ¹⁵ | B14 | B ⁷ |
| 17 | 1 | CLK2/I | - | CLK2/I | - |
| 18 | 1 | B0 | B ⁰ | C0 | C ⁰ |
| 19 | 1 | B1 | B ¹ | C2 | C ¹ |
| 20 | 1 | B2 | B ² | C4 | C ² |
| 21 | 1 | B3 | B ³ | C6 | C ³ |
| 22 | 1 | B4 | B ⁴ | C8 | C ⁴ |
| 23 | - | TMS | - | TMS | - |
| 24 | 1 | B5 | B ⁵ | C10 | C ⁵ |
| 25 | 1 | B6 | B ⁶ | C12 | C ⁶ |
| 26 | 1 | B7 | B ⁷ | C14 | C ⁷ |
| 27 | 1 | GND (Bank 1) | - | GND (Bank 1) | - |
| 28 | 1 | VCCO (Bank 1) | - | VCCO (Bank 1) | - |
| 29 | 1 | B8 | B ⁸ | D0 | D ⁰ |
| 30 | 1 | B9 | B ⁹ | D2 | D ¹ |
| 31 | 1 | B10 | B ¹⁰ | D4 | D ² |
| 32 | - | TDO | - | TDO | - |
| 33 | - | VCC | - | VCC | - |
| 34 | - | GND | - | GND | - |
| 35 | 1 | B12 | B ¹² | D8 | D ⁴ |
| 36 | 1 | B13 | B ¹³ | D10 | D ⁵ |
| 37 | 1 | B14 | B ¹⁴ | D12 | D ⁶ |
| 38 | 1 | B15/GOE1 | B ¹⁵ | D14/GOE1 | D ⁷ |
| 39 | 0 | CLK0/I | - | CLK0/I | - |
| 40 | 0 | A0/GOE0 | A ⁰ | A0/GOE0 | A ⁰ |
| 41 | 0 | A1 | A ¹ | A2 | A ¹ |

**ispMACH 4064V/B/C/Z, 4128V/B/C/Z, 4256V/B/C/Z Logic Signal Connections:
100-Pin TQFP (Cont.)**

| Pin Number | Bank Number | ispMACH 4064V/B/C/Z | | ispMACH 4128V/B/C/Z | | ispMACH 4256V/B/C/Z | |
|------------|-------------|---------------------|----------------|---------------------|----------------|---------------------|----------------|
| | | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP |
| 83 | 1 | VCCO (Bank 1) | - | VCCO (Bank 1) | - | VCCO (Bank 1) | - |
| 84 | 1 | D3 | D ³ | H6 | H ³ | P12 | P ³ |
| 85 | 1 | D2 | D ² | H4 | H ² | P10 | P ² |
| 86 | 1 | D1 | D ¹ | H2 | H ¹ | P6 | P ¹ |
| 87 | 1 | D0/GOE1 | D ⁰ | H0/GOE1 | H ⁰ | P2/OE1 | P ⁰ |
| 88 | 1 | CLK3/I | - | CLK3/I | - | CLK3/I | - |
| 89 | 0 | CLK0/I | - | CLK0/I | - | CLK0/I | - |
| 90 | - | VCC | - | VCC | - | VCC | - |
| 91 | 0 | A0/GOE0 | A ⁰ | A0/GOE0 | A ⁰ | A2/GOE0 | A ⁰ |
| 92 | 0 | A1 | A ¹ | A2 | A ¹ | A6 | A ¹ |
| 93 | 0 | A2 | A ² | A4 | A ² | A10 | A ² |
| 94 | 0 | A3 | A ³ | A6 | A ³ | A12 | A ³ |
| 95 | 0 | VCCO (Bank 0) | - | VCCO (Bank 0) | - | VCCO (Bank 0) | - |
| 96 | 0 | GND (Bank 0) | - | GND (Bank 0) | - | GND (Bank 0) | - |
| 97 | 0 | A4 | A ⁴ | A8 | A ⁴ | B2 | B ⁰ |
| 98 | 0 | A5 | A ⁵ | A10 | A ⁵ | B6 | B ¹ |
| 99 | 0 | A6 | A ⁶ | A12 | A ⁶ | B10 | B ² |
| 100 | 0 | A7 | A ⁷ | A14 | A ⁷ | B12 | B ³ |

*This pin is input only.

ispMACH 4128V/B/C Logic Signal Connections: 128-Pin TQFP

| Pin Number | Bank Number | ispMACH 4128V/B/C | |
|------------|-------------|-------------------|-----------------|
| | | GLB/MC/Pad | ORP |
| 1 | 0 | GND | - |
| 2 | 0 | TDI | - |
| 3 | 0 | VCCO (Bank 0) | - |
| 4 | 0 | B0 | B ⁰ |
| 5 | 0 | B1 | B ¹ |
| 6 | 0 | B2 | B ² |
| 7 | 0 | B4 | B ³ |
| 8 | 0 | B5 | B ⁴ |
| 9 | 0 | B6 | B ⁵ |
| 10 | 0 | GND (Bank 0) | - |
| 11 | 0 | B8 | B ⁶ |
| 12 | 0 | B9 | B ⁷ |
| 13 | 0 | B10 | B ⁸ |
| 14 | 0 | B12 | B ⁹ |
| 15 | 0 | B13 | B ¹⁰ |
| 16 | 0 | B14 | B ¹¹ |
| 17 | 0 | VCCO (Bank 0) | - |
| 18 | 0 | C14 | C ¹¹ |

ispMACH 4128V/B/C Logic Signal Connections: 128-Pin TQFP (Cont.)

| Pin Number | Bank Number | ispMACH 4128V/B/C | |
|------------|-------------|-------------------|-----------------|
| | | GLB/MC/Pad | ORP |
| 19 | 0 | C13 | C ¹⁰ |
| 20 | 0 | C12 | C ⁹ |
| 21 | 0 | C10 | C ⁸ |
| 22 | 0 | C9 | C ⁷ |
| 23 | 0 | C8 | C ⁶ |
| 24 | 0 | GND (Bank 0) | - |
| 25 | 0 | C6 | C ⁵ |
| 26 | 0 | C5 | C ⁴ |
| 27 | 0 | C4 | C ³ |
| 28 | 0 | C2 | C ² |
| 29 | 0 | C0 | C ⁰ |
| 30 | 0 | VCCO (Bank 0) | - |
| 31 | 0 | TCK | - |
| 32 | 0 | VCC | - |
| 33 | 0 | GND | - |
| 34 | 0 | D14 | D ¹¹ |
| 35 | 0 | D13 | D ¹⁰ |
| 36 | 0 | D12 | D ⁹ |
| 37 | 0 | D10 | D ⁸ |
| 38 | 0 | D9 | D ⁷ |
| 39 | 0 | D8 | D ⁶ |
| 40 | 0 | GND (Bank 0) | - |
| 41 | 0 | VCCO (Bank 0) | - |
| 42 | 0 | D6 | D ⁵ |
| 43 | 0 | D5 | D ⁴ |
| 44 | 0 | D4 | D ³ |
| 45 | 0 | D2 | D ² |
| 46 | 0 | D1 | D ¹ |
| 47 | 0 | D0 | D ⁰ |
| 48 | 0 | CLK1/I | - |
| 49 | 1 | GND (Bank 1) | - |
| 50 | 1 | CLK2/I | - |
| 51 | 1 | VCC | - |
| 52 | 1 | E0 | E ⁰ |
| 53 | 1 | E1 | E ¹ |
| 54 | 1 | E2 | E ² |
| 55 | 1 | E4 | E ³ |
| 56 | 1 | E5 | E ⁴ |
| 57 | 1 | E6 | E ⁵ |
| 58 | 1 | VCCO (Bank 1) | - |
| 59 | 1 | GND (Bank 1) | - |
| 60 | 1 | E8 | E ⁶ |
| 61 | 1 | E9 | E ⁷ |

ispMACH 4128V/B/C Logic Signal Connections: 128-Pin TQFP (Cont.)

| Pin Number | Bank Number | ispMACH 4128V/B/C | |
|------------|-------------|-------------------|-----------------|
| | | GLB/MC/Pad | ORP |
| 105 | 1 | VCCO (Bank 1) | - |
| 106 | 1 | H6 | H ⁵ |
| 107 | 1 | H5 | H ⁴ |
| 108 | 1 | H4 | H ³ |
| 109 | 1 | H2 | H ² |
| 110 | 1 | H1 | H ¹ |
| 111 | 1 | H0/GOE1 | H ⁰ |
| 112 | 1 | CLK3/I | - |
| 113 | 0 | GND (Bank 0) | - |
| 114 | 0 | CLK0/I | - |
| 115 | 0 | VCC | - |
| 116 | 0 | A0/GOE0 | A ⁰ |
| 117 | 0 | A1 | A ¹ |
| 118 | 0 | A2 | A ² |
| 119 | 0 | A4 | A ³ |
| 120 | 0 | A5 | A ⁴ |
| 121 | 0 | A6 | A ⁵ |
| 122 | 0 | VCCO (Bank 0) | - |
| 123 | 0 | GND (Bank 0) | - |
| 124 | 0 | A8 | A ⁶ |
| 125 | 0 | A9 | A ⁷ |
| 126 | 0 | A10 | A ⁸ |
| 127 | 0 | A12 | A ⁹ |
| 128 | 0 | A14 | A ¹¹ |

**ispMACH 4064Z, 4128Z and 4256Z Logic Signal Connections:
132-Ball csBGA**

| Ball Number | Bank Number | ispMACH 4064Z | | ispMACH 4128Z | | ispMACH 4256Z | |
|-------------|-------------|---------------|-----------------|---------------|----------------|---------------|----------------|
| | | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP |
| B1 | - | GND | - | GND | - | GND | - |
| B2 | - | TDI | - | TDI | - | TDI | - |
| C1 | 0 | NC | - | VCCO (Bank 0) | - | VCCO (Bank 0) | - |
| C3 | 0 | NC | - | B0 | B ⁰ | C12 | C ⁶ |
| C2 | 0 | A8 | A ⁸ | B1 | B ¹ | C10 | C ⁵ |
| D1 | 0 | A9 | A ⁹ | B2 | B ² | C8 | C ⁴ |
| D3 | 0 | A10 | A ¹⁰ | B4 | B ³ | C6 | C ³ |
| D2 | 0 | A11 | A ¹¹ | B5 | B ⁴ | C4 | C ² |
| E1 | 0 | NC | - | B6 | B ⁵ | C2 | C ¹ |
| E2 | 0 | GND (Bank 0) | - | GND (Bank 0) | - | GND (Bank 0) | - |

**ispMACH 4064Z, 4128Z and 4256Z Logic Signal Connections:
132-Ball csBGA (Cont.)**

| Ball Number | Bank Number | ispMACH 4064Z | | ispMACH 4128Z | | ispMACH 4256Z | |
|-------------|-------------|---------------|-----------------|---------------|-----------------|---------------|----------------|
| | | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP |
| E3 | 0 | NC | - | B8 | B ⁶ | D12 | D ⁶ |
| F2 | 0 | A12 | A ¹² | B9 | B ⁷ | D10 | D ⁵ |
| F1 | 0 | A13 | A ¹³ | B10 | B ⁸ | D8 | D ⁴ |
| F3 | 0 | A14 | A ¹⁴ | B12 | B ⁹ | D6 | D ³ |
| G1 | 0 | A15 | A ¹⁵ | B13 | B ¹⁰ | D4 | D ² |
| G2 | 0 | I | - | B14 | B ¹¹ | D2 | D ¹ |
| G3 | 0 | VCCO (Bank 0) | - | VCCO (Bank 0) | - | VCCO (Bank 0) | - |
| H2 | 0 | NC | - | C14 | C ¹¹ | E2 | E ¹ |
| H1 | 0 | B15 | B ¹⁵ | C13 | C ¹⁰ | E4 | E ² |
| H3 | 0 | B14 | B ¹⁴ | C12 | C ⁹ | E6 | E ³ |
| J1 | 0 | B13 | B ¹³ | C10 | C ⁸ | E8 | E ⁴ |
| J2 | 0 | B12 | B ¹² | C9 | C ⁷ | E10 | E ⁵ |
| J3 | 0 | NC | - | C8 | C ⁶ | E12 | E ⁶ |
| K2 | 0 | GND (Bank 0) | - | GND (Bank 0) | - | GND (Bank 0) | - |
| K1 | 0 | NC | - | C6 | C ⁵ | F2 | F ¹ |
| K3 | 0 | B11 | B ¹¹ | C5 | C ⁴ | F4 | F ² |
| L2 | 0 | B10 | B ¹⁰ | C4 | C ³ | F6 | F ³ |
| L1 | 0 | B9 | B ⁹ | C2 | C ² | F8 | F ⁴ |
| L3 | 0 | B8 | B ⁸ | C1 | C ¹ | F10 | F ⁵ |
| M1 | 0 | I | - | C0 | C ⁰ | F12 | F ⁶ |
| M2 | 0 | NC | - | VCCO (Bank 0) | - | VCCO (Bank 0) | - |
| N1 | - | TCK | - | TCK | - | TCK | - |
| P1 | - | VCC | - | VCC | - | VCC | - |
| P2 | - | GND | - | GND | - | GND | - |
| N2 | 0 | I | - | D14 | D ¹¹ | G12 | G ⁶ |
| P3 | 0 | B7 | B ⁷ | D13 | D ¹⁰ | G10 | G ⁵ |
| M3 | 0 | B6 | B ⁶ | D12 | D ⁹ | G8 | G ⁴ |
| N3 | 0 | B5 | B ⁵ | D10 | D ⁸ | G6 | G ³ |
| P4 | 0 | B4 | B ⁴ | D9 | D ⁷ | G4 | G ² |
| M4 | 0 | NC | - | D8 | D ⁶ | G2 | G ¹ |
| N4 | 0 | GND (Bank 0) | - | GND (Bank 0) | - | GND (Bank 0) | - |
| P5 | 0 | VCCO (Bank 0) | - | VCCO (Bank 0) | - | VCCO (Bank 0) | - |
| N5 | 0 | NC | - | D6 | D ⁵ | H12 | H ⁶ |
| M5 | 0 | B3 | B ³ | D5 | D ⁴ | H10 | H ⁵ |
| N6 | 0 | B2 | B ² | D4 | D ³ | H8 | H ⁴ |
| P6 | 0 | B1 | B ¹ | D2 | D ² | H6 | H ³ |
| M6 | 0 | B0 | B ⁰ | D1 | D ¹ | H4 | H ² |
| P7 | 0 | NC | - | D0 | D ⁰ | H2 | H ¹ |
| N7 | 0 | CLK1/I | - | CLK1/I | - | CLK1/I | - |
| M7 | 1 | CLK2/I | - | CLK2/I | - | CLK2/I | - |
| N8 | - | VCC | - | VCC | - | VCC | - |

**ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections:
256-Ball ftBGA/fpBGA (Cont.)**

| Ball Number | I/O Bank | ispMACH 4256V/B/C 128-I/O | | ispMACH 4256V/B/C 160-I/O | | ispMACH 4384V/B/C | | ispMACH 4512V/B/C | |
|-------------|----------|------------------------------|------------------|------------------------------|------------------|-------------------|-------------------|-------------------|-------------------|
| | | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP |
| R5 | 0 | NC | - | NC | - | NC | - | L4 | L [^] 1 |
| T5 | 0 | NC | - | NC | - | I2 | I [^] 1 | L8 | L [^] 2 |
| R6 | 0 | NC | - | NC | - | I0 | I [^] 0 | L12 | L [^] 3 |
| T6 | 0 | NC | - | H14 | H [^] 9 | G12 | G [^] 6 | M8 | M [^] 2 |
| N7 | 0 | NC | - | H12 | H [^] 8 | G14 | G [^] 7 | M12 | M [^] 3 |
| P7 | 0 | H14 | H [^] 7 | H10 | H [^] 7 | L14 | L [^] 7 | P14 | P [^] 7 |
| R7 | 0 | H12 | H [^] 6 | H9 | H [^] 6 | L12 | L [^] 6 | P12 | P [^] 6 |
| L8 | 0 | H10 | H [^] 5 | H8 | H [^] 5 | L10 | L [^] 5 | P10 | P [^] 5 |
| T7 | 0 | H8 | H [^] 4 | H6 | H [^] 4 | L8 | L [^] 4 | P8 | P [^] 4 |
| M8 | 0 | H6 | H [^] 3 | H4 | H [^] 3 | L6 | L [^] 3 | P6 | P [^] 3 |
| N8 | 0 | H4 | H [^] 2 | H2 | H [^] 2 | L4 | L [^] 2 | P4 | P [^] 2 |
| R8 | 0 | H2 | H [^] 1 | H1 | H [^] 1 | L2 | L [^] 1 | P2 | P [^] 1 |
| P8 | 0 | H0 | H [^] 0 | H0 | H [^] 0 | L0 | L [^] 0 | P0 | P [^] 0 |
| - | - | GND | - | GND | - | GND | - | GND | - |
| T8 | 0 | CLK1/I | - | CLK1/I | - | CLK1/I | - | CLK1/I | - |
| - | 1 | GND (Bank 1) | - | GND (Bank 1) | - | GND (Bank 1) | - | GND (Bank 1) | - |
| N9 | 1 | CLK2/I | - | CLK2/I | - | CLK2/I | - | CLK2/I | - |
| - | - | VCC | - | VCC | - | VCC | - | VCC | - |
| P9 | 1 | I0 | I [^] 0 | I0 | I [^] 0 | M0 | M [^] 0 | AX0 | AX [^] 0 |
| R9 | 1 | I2 | I [^] 1 | I1 | I [^] 1 | M2 | M [^] 1 | AX2 | AX [^] 1 |
| T9 | 1 | I4 | I [^] 2 | I2 | I [^] 2 | M4 | M [^] 2 | AX4 | AX [^] 2 |
| T10 | 1 | I6 | I [^] 3 | I4 | I [^] 3 | M6 | M [^] 3 | AX6 | AX [^] 3 |
| R10 | 1 | I8 | I [^] 4 | I6 | I [^] 4 | M8 | M [^] 4 | AX8 | AX [^] 4 |
| M9 | 1 | I10 | I [^] 5 | I8 | I [^] 5 | M10 | M [^] 5 | AX10 | AX [^] 5 |
| P10 | 1 | I12 | I [^] 6 | I9 | I [^] 6 | M12 | M [^] 6 | AX12 | AX [^] 6 |
| L9 | 1 | I14 | I [^] 7 | I10 | I [^] 7 | M14 | M [^] 7 | AX14 | AX [^] 7 |
| N10 | 1 | NC | - | I12 | I [^] 8 | BX14 | BX [^] 7 | DX0 | DX [^] 0 |
| T11 | 1 | NC | - | I14 | I [^] 9 | BX12 | BX [^] 6 | DX4 | DX [^] 1 |
| R11 | 1 | NC | - | NC | - | P0 | P [^] 0 | EX0 | EX [^] 0 |
| T12 | 1 | NC | - | NC | - | P2 | P [^] 1 | EX4 | EX [^] 1 |
| N12 | 1 | NC | - | NC | - | NC | - | EX8 | EX [^] 2 |
| - | 1 | VCCO (Bank 1) | - | VCCO (Bank 1) | - | VCCO (Bank 1) | - | VCCO (Bank 1) | - |
| - | 1 | GND (Bank 1) | - | GND (Bank 1) | - | GND (Bank 1) | - | GND (Bank 1) | - |
| R12 | 1 | NC | - | NC | - | NC | - | EX12 | EX [^] 3 |
| T13 | 1 | NC | - | J0 | J [^] 0 | BX10 | BX [^] 5 | DX8 | DX [^] 2 |
| P12 | 1 | NC | - | J1 | J [^] 1 | BX8 | BX [^] 4 | DX12 | DX [^] 3 |
| M10 | 1 | J0 | J [^] 0 | J2 | J [^] 2 | N0 | N [^] 0 | BX0 | BX [^] 0 |
| R13 | 1 | J2 | J [^] 1 | J4 | J [^] 3 | N2 | N [^] 1 | BX2 | BX [^] 1 |
| L10 | 1 | J4 | J [^] 2 | J6 | J [^] 4 | N4 | N [^] 2 | BX4 | BX [^] 2 |
| T14 | 1 | J6 | J [^] 3 | J8 | J [^] 5 | N6 | N [^] 3 | BX6 | BX [^] 3 |
| M11 | 1 | J8 | J [^] 4 | J9 | J [^] 6 | N8 | N [^] 4 | BX8 | BX [^] 4 |

ispMACH 4000C (1.8V) Industrial Devices

| Family | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|---------|-------------------------------|------------|---------|-----------------|---------|----------------|-----|-------|
| LC4032C | LC4032C-5T48I | 32 | 1.8 | 5 | TQFP | 48 | 32 | I |
| | LC4032C-75T48I | 32 | 1.8 | 7.5 | TQFP | 48 | 32 | I |
| | LC4032C-10T48I | 32 | 1.8 | 10 | TQFP | 48 | 32 | I |
| | LC4032C-5T44I | 32 | 1.8 | 5 | TQFP | 44 | 30 | I |
| | LC4032C-75T44I | 32 | 1.8 | 7.5 | TQFP | 44 | 30 | I |
| | LC4032C-10T44I | 32 | 1.8 | 10 | TQFP | 44 | 30 | I |
| LC4064C | LC4064C-5T100I | 64 | 1.8 | 5 | TQFP | 100 | 64 | I |
| | LC4064C-75T100I | 64 | 1.8 | 7.5 | TQFP | 100 | 64 | I |
| | LC4064C-10T100I | 64 | 1.8 | 10 | TQFP | 100 | 64 | I |
| | LC4064C-5T48I | 64 | 1.8 | 5 | TQFP | 48 | 32 | I |
| | LC4064C-75T48I | 64 | 1.8 | 7.5 | TQFP | 48 | 32 | I |
| | LC4064C-10T48I | 64 | 1.8 | 10 | TQFP | 48 | 32 | I |
| | LC4064C-5T44I | 64 | 1.8 | 5 | TQFP | 44 | 30 | I |
| | LC4064C-75T44I | 64 | 1.8 | 7.5 | TQFP | 44 | 30 | I |
| | LC4064C-10T44I | 64 | 1.8 | 10 | TQFP | 44 | 30 | I |
| LC4128C | LC4128C-5T128I | 128 | 1.8 | 5 | TQFP | 128 | 92 | I |
| | LC4128C-75T128I | 128 | 1.8 | 7.5 | TQFP | 128 | 92 | I |
| | LC4128C-10T128I | 128 | 1.8 | 10 | TQFP | 128 | 92 | I |
| | LC4128C-5T100I | 128 | 1.8 | 5 | TQFP | 100 | 64 | I |
| | LC4128C-75T100I | 128 | 1.8 | 7.5 | TQFP | 100 | 64 | I |
| | LC4128C-10T100I | 128 | 1.8 | 10 | TQFP | 100 | 64 | I |
| LC4256C | LC4256C-5FT256AI | 256 | 1.8 | 5 | ftBGA | 256 | 128 | I |
| | LC4256C-75FT256AI | 256 | 1.8 | 7.5 | ftBGA | 256 | 128 | I |
| | LC4256C-10FT256AI | 256 | 1.8 | 10 | ftBGA | 256 | 128 | I |
| | LC4256C-5FT256BI | 256 | 1.8 | 5 | ftBGA | 256 | 160 | I |
| | LC4256C-75FT256BI | 256 | 1.8 | 7.5 | ftBGA | 256 | 160 | I |
| | LC4256C-10FT256BI | 256 | 1.8 | 10 | ftBGA | 256 | 160 | I |
| | LC4256C-5F256AI ¹ | 256 | 1.8 | 5 | fpBGA | 256 | 128 | I |
| | LC4256C-75F256AI ¹ | 256 | 1.8 | 7.5 | fpBGA | 256 | 128 | I |
| | LC4256C-10F256AI ¹ | 256 | 1.8 | 10 | fpBGA | 256 | 128 | I |
| | LC4256C-5F256BI ¹ | 256 | 1.8 | 5 | fpBGA | 256 | 160 | I |
| | LC4256C-75F256BI ¹ | 256 | 1.8 | 7.5 | fpBGA | 256 | 160 | I |
| | LC4256C-10F256BI ¹ | 256 | 1.8 | 10 | fpBGA | 256 | 160 | I |
| | LC4256C-5T176I | 256 | 1.8 | 5 | TQFP | 176 | 128 | I |
| | LC4256C-75T176I | 256 | 1.8 | 7.5 | TQFP | 176 | 128 | I |
| | LC4256C-10T176I | 256 | 1.8 | 10 | TQFP | 176 | 128 | I |
| | LC4256C-5T100I | 256 | 1.8 | 5 | TQFP | 100 | 64 | I |
| | LC4256C-75T100I | 256 | 1.8 | 7.5 | TQFP | 100 | 64 | I |
| | LC4256C-10T100I | 256 | 1.8 | 10 | TQFP | 100 | 64 | I |

ispMACH 4000B (2.5V) Lead-Free Commercial Devices (Cont.)

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|---------|-------------------------------|------------|---------|-----------------|-----------------|----------------|-----|-------|
| LC4384B | LC4384B-35FTN256C | 384 | 2.5 | 3.5 | Lead-Free ftBGA | 256 | 192 | C |
| | LC4384B-5FTN256C | 384 | 2.5 | 5 | Lead-Free ftBGA | 256 | 192 | C |
| | LC4384B-75FTN256C | 384 | 2.5 | 7.5 | Lead-Free ftBGA | 256 | 192 | C |
| | LC4384B-35FN256C ¹ | 384 | 2.5 | 3.5 | Lead-Free fpBGA | 256 | 192 | C |
| | LC4384B-5FN256C ¹ | 384 | 2.5 | 5 | Lead-Free fpBGA | 256 | 192 | C |
| | LC4384B-75FN256C ¹ | 384 | 2.5 | 7.5 | Lead-Free fpBGA | 256 | 192 | C |
| | LC4384B-35TN176C | 384 | 2.5 | 3.5 | Lead-Free TQFP | 176 | 128 | C |
| | LC4384B-5TN176C | 384 | 2.5 | 5 | Lead-Free TQFP | 176 | 128 | C |
| | LC4384B-75TN176C | 384 | 2.5 | 7.5 | Lead-Free TQFP | 176 | 128 | C |
| LC4512B | LC4512B-35FTN256C | 512 | 2.5 | 3.5 | Lead-Free ftBGA | 256 | 208 | C |
| | LC4512B-5FTN256C | 512 | 2.5 | 5 | Lead-Free ftBGA | 256 | 208 | C |
| | LC4512B-75FTN256C | 512 | 2.5 | 7.5 | Lead-Free ftBGA | 256 | 208 | C |
| | LC4512B-35FN256C ¹ | 512 | 2.5 | 3.5 | Lead-Free fpBGA | 256 | 208 | C |
| | LC4512B-5FN256C ¹ | 512 | 2.5 | 5 | Lead-Free fpBGA | 256 | 208 | C |
| | LC4512B-75FN256C ¹ | 512 | 2.5 | 7.5 | Lead-Free fpBGA | 256 | 208 | C |
| | LC4512B-35TN176C | 512 | 2.5 | 3.5 | Lead-Free TQFP | 176 | 128 | C |
| | LC4512B-5TN176C | 512 | 2.5 | 5 | Lead-Free TQFP | 176 | 128 | C |
| | LC4512B-75TN176C | 512 | 2.5 | 7.5 | Lead-Free TQFP | 176 | 128 | C |

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000B (2.5V) Lead-Free Industrial Devices

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|---------|------------------|------------|---------|-----------------|----------------|----------------|-----|-------|
| LC4032B | LC4032B-5TN48I | 32 | 2.5 | 5 | Lead-Free TQFP | 48 | 32 | I |
| | LC4032B-75TN48I | 32 | 2.5 | 7.5 | Lead-Free TQFP | 48 | 32 | I |
| | LC4032B-10TN48I | 32 | 2.5 | 10 | Lead-Free TQFP | 48 | 32 | I |
| | LC4032B-5TN44I | 32 | 2.5 | 5 | Lead-Free TQFP | 44 | 30 | I |
| | LC4032B-75TN44I | 32 | 2.5 | 7.5 | Lead-Free TQFP | 44 | 30 | I |
| | LC4032B-10TN44I | 32 | 2.5 | 10 | Lead-Free TQFP | 44 | 30 | I |
| LC4064B | LC4064B-5TN100I | 64 | 2.5 | 5 | Lead-Free TQFP | 100 | 64 | I |
| | LC4064B-75TN100I | 64 | 2.5 | 7.5 | Lead-Free TQFP | 100 | 64 | I |
| | LC4064B-10TN100I | 64 | 2.5 | 10 | Lead-Free TQFP | 100 | 64 | I |
| | LC4064B-5TN48I | 64 | 2.5 | 5 | Lead-Free TQFP | 48 | 32 | I |
| | LC4064B-75TN48I | 64 | 2.5 | 7.5 | Lead-Free TQFP | 48 | 32 | I |
| | LC4064B-10TN48I | 64 | 2.5 | 10 | Lead-Free TQFP | 48 | 32 | I |
| | LC4064B-5TN44I | 64 | 2.5 | 5 | Lead-Free TQFP | 44 | 30 | I |
| | LC4064B-75TN44I | 64 | 2.5 | 7.5 | Lead-Free TQFP | 44 | 30 | I |
| | LC4064B-10TN44I | 64 | 2.5 | 10 | Lead-Free TQFP | 44 | 30 | I |

ispMACH 4000V (3.3V) Lead-Free Commercial Devices

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|---------|------------------|------------|---------|-----------------|----------------|----------------|-----|-------|
| LC4032V | LC4032V-25TN48C | 32 | 3.3 | 2.5 | Lead-free TQFP | 48 | 32 | C |
| | LC4032V-5TN48C | 32 | 3.3 | 5 | Lead-free TQFP | 48 | 32 | C |
| | LC4032V-75TN48C | 32 | 3.3 | 7.5 | Lead-free TQFP | 48 | 32 | C |
| | LC4032V-25TN44C | 32 | 3.3 | 2.5 | Lead-free TQFP | 44 | 30 | C |
| | LC4032V-5TN44C | 32 | 3.3 | 5 | Lead-free TQFP | 44 | 30 | C |
| | LC4032V-75TN44C | 32 | 3.3 | 7.5 | Lead-free TQFP | 44 | 30 | C |
| LC4064V | LC4064V-25TN100C | 64 | 3.3 | 2.5 | Lead-free TQFP | 100 | 64 | C |
| | LC4064V-5TN100C | 64 | 3.3 | 5 | Lead-free TQFP | 100 | 64 | C |
| | LC4064V-75TN100C | 64 | 3.3 | 7.5 | Lead-free TQFP | 100 | 64 | C |
| | LC4064V-25TN48C | 64 | 3.3 | 2.5 | Lead-free TQFP | 48 | 32 | C |
| | LC4064V-5TN48C | 64 | 3.3 | 5 | Lead-free TQFP | 48 | 32 | C |
| | LC4064V-75TN48C | 64 | 3.3 | 7.5 | Lead-free TQFP | 48 | 32 | C |
| | LC4064V-25TN44C | 64 | 3.3 | 2.5 | Lead-free TQFP | 44 | 30 | C |
| | LC4064V-5TN44C | 64 | 3.3 | 5 | Lead-free TQFP | 44 | 30 | C |
| | LC4064V-75TN44C | 64 | 3.3 | 7.5 | Lead-free TQFP | 44 | 30 | C |
| LC4128V | LC4128V-27TN144C | 128 | 3.3 | 2.7 | Lead-free TQFP | 144 | 96 | C |
| | LC4128V-5TN144C | 128 | 3.3 | 5 | Lead-free TQFP | 144 | 96 | C |
| | LC4128V-75TN144C | 128 | 3.3 | 7.5 | Lead-free TQFP | 144 | 96 | C |
| | LC4128V-27TN128C | 128 | 3.3 | 2.7 | Lead-free TQFP | 128 | 92 | C |
| | LC4128V-5TN128C | 128 | 3.3 | 5 | Lead-free TQFP | 128 | 92 | C |
| | LC4128V-75TN128C | 128 | 3.3 | 7.5 | Lead-free TQFP | 128 | 92 | C |
| | LC4128V-27TN100C | 128 | 3.3 | 2.7 | Lead-free TQFP | 100 | 64 | C |
| | LC4128V-5TN100C | 128 | 3.3 | 5 | Lead-free TQFP | 100 | 64 | C |
| | LC4128V-75TN100C | 128 | 3.3 | 7.5 | Lead-free TQFP | 100 | 64 | C |

ispMACH 4000V (3.3V) Lead-Free Industrial Devices (Cont.)

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|---------|--------------------------------|------------|---------|-----------------|-----------------|----------------|-----|-------|
| LC4256V | LC4256V-5FTN256AI | 256 | 3.3 | 5 | Lead-free ftBGA | 256 | 128 | I |
| | LC4256V-75FTN256AI | 256 | 3.3 | 7.5 | Lead-free ftBGA | 256 | 128 | I |
| | LC4256V-10FTN256AI | 256 | 3.3 | 10 | Lead-free ftBGA | 256 | 128 | I |
| | LC4256V-5FTN256BI | 256 | 3.3 | 5 | Lead-free ftBGA | 256 | 160 | I |
| | LC4256V-75FTN256BI | 256 | 3.3 | 7.5 | Lead-free ftBGA | 256 | 160 | I |
| | LC4256V-10FTN256BI | 256 | 3.3 | 10 | Lead-free ftBGA | 256 | 160 | I |
| | LC4256V-5FN256AI ¹ | 256 | 3.3 | 5 | Lead-free fpBGA | 256 | 128 | I |
| | LC4256V-75FN256AI ¹ | 256 | 3.3 | 7.5 | Lead-free fpBGA | 256 | 128 | I |
| | LC4256V-10FN256AI ¹ | 256 | 3.3 | 10 | Lead-free fpBGA | 256 | 128 | I |
| | LC4256V-5FN256BI ¹ | 256 | 3.3 | 5 | Lead-free fpBGA | 256 | 160 | I |
| | LC4256V-75FN256BI ¹ | 256 | 3.3 | 7.5 | Lead-free fpBGA | 256 | 160 | I |
| | LC4256V-10FN256BI ¹ | 256 | 3.3 | 10 | Lead-free fpBGA | 256 | 160 | I |
| | LC4256V-5TN176I | 256 | 3.3 | 5 | Lead-free TQFP | 176 | 128 | I |
| | LC4256V-75TN176I | 256 | 3.3 | 7.5 | Lead-free TQFP | 176 | 128 | I |
| | LC4256V-10TN176I | 256 | 3.3 | 10 | Lead-free TQFP | 176 | 128 | I |
| | LC4256V-5TN144I | 256 | 3.3 | 5 | Lead-free TQFP | 144 | 96 | I |
| | LC4256V-75TN144I | 256 | 3.3 | 7.5 | Lead-free TQFP | 144 | 96 | I |
| | LC4256V-10TN144I | 256 | 3.3 | 10 | Lead-free TQFP | 144 | 96 | I |
| | LC4256V-5TN100I | 256 | 3.3 | 5 | Lead-free TQFP | 100 | 64 | I |
| | LC4256V-75TN100I | 256 | 3.3 | 7.5 | Lead-free TQFP | 100 | 64 | I |
| | LC4256V-10TN100I | 256 | 3.3 | 10 | Lead-free TQFP | 100 | 64 | I |
| LC4384V | LC4384V-5FTN256I | 384 | 3.3 | 5 | Lead-free ftBGA | 256 | 192 | I |
| | LC4384V-75FTN256I | 384 | 3.3 | 7.5 | Lead-free ftBGA | 256 | 192 | I |
| | LC4384V-10FTN256I | 384 | 3.3 | 10 | Lead-free ftBGA | 256 | 192 | I |
| | LC4384V-5FN256I ¹ | 384 | 3.3 | 5 | Lead-free fpBGA | 256 | 192 | I |
| | LC4384V-75FN256I ¹ | 384 | 3.3 | 7.5 | Lead-free fpBGA | 256 | 192 | I |
| | LC4384V-10FN256I ¹ | 384 | 3.3 | 10 | Lead-free fpBGA | 256 | 192 | I |
| | LC4384V-5TN176I | 384 | 3.3 | 5 | Lead-free TQFP | 176 | 128 | I |
| | LC4384V-75TN176I | 384 | 3.3 | 7.5 | Lead-free TQFP | 176 | 128 | I |
| | LC4384V-10TN176I | 384 | 3.3 | 10 | Lead-free TQFP | 176 | 128 | I |
| LC4512V | LC4512V-5FTN256I | 512 | 3.3 | 5 | Lead-free ftBGA | 256 | 208 | I |
| | LC4512V-75FTN256I | 512 | 3.3 | 7.5 | Lead-free ftBGA | 256 | 208 | I |
| | LC4512V-10FTN256I | 512 | 3.3 | 10 | Lead-free ftBGA | 256 | 208 | I |
| | LC4512V-5FN256I ¹ | 512 | 3.3 | 5 | Lead-free fpBGA | 256 | 208 | I |
| | LC4512V-75FN256I ¹ | 512 | 3.3 | 7.5 | Lead-free fpBGA | 256 | 208 | I |
| | LC4512V-10FN256I ¹ | 512 | 3.3 | 10 | Lead-free fpBGA | 256 | 208 | I |
| | LC4512V-5TN176I | 512 | 3.3 | 5 | Lead-free TQFP | 176 | 128 | I |
| | LC4512V-75TN176I | 512 | 3.3 | 7.5 | Lead-free TQFP | 176 | 128 | I |
| | LC4512V-10TN176I | 512 | 3.3 | 10 | Lead-free TQFP | 176 | 128 | I |

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000V (3.3V) Lead-Free Extended Temperature Devices

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|---------|------------------|------------|---------|-----------------|----------------|----------------|-----|-------|
| LC4032V | LC4032V-75TN48E | 32 | 3.3 | 7.5 | Lead-free TQFP | 48 | 32 | E |
| | LC4032V-75TN44E | 32 | 3.3 | 7.5 | Lead-free TQFP | 44 | 30 | E |
| LC4064V | LC4064V-75TN100E | 64 | 3.3 | 7.5 | Lead-free TQFP | 100 | 64 | E |
| | LC4064V-75TN48E | 64 | 3.3 | 7.5 | Lead-free TQFP | 48 | 32 | E |
| | LC4064V-75TN44E | 64 | 3.3 | 7.5 | Lead-free TQFP | 44 | 30 | E |
| LC4128V | LC4128V-75TN144E | 128 | 3.3 | 7.5 | Lead-free TQFP | 144 | 96 | E |
| | LC4128V-75TN128E | 128 | 3.3 | 7.5 | Lead-free TQFP | 128 | 92 | E |
| | LC4128V-75TN100E | 128 | 3.3 | 7.5 | Lead-free TQFP | 100 | 64 | E |
| LC4256V | LC4256V-75TN176E | 256 | 3.3 | 7.5 | Lead-free TQFP | 176 | 128 | E |
| | LC4256V-75TN144E | 256 | 3.3 | 7.5 | Lead-free TQFP | 144 | 96 | E |
| | LC4256V-75TN100E | 256 | 3.3 | 7.5 | Lead-free TQFP | 100 | 64 | E |

For Further Information

In addition to this data sheet, the following technical notes may be helpful when designing with the ispMACH 4000V/B/C/Z family:

- TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#)
- TN1005, [Power Estimation in ispMACH 4000V/B/C/Z Devices](#)

Revision History

| Date | Version | Change Summary |
|---------------|---------|---|
| — | — | Previous Lattice releases. |
| July 2003 | 17z | Changed device status for LC4064ZC and LC4128ZC to production release and updated/added AC and DC parameters as well as ordering part numbers for LC4064ZC and LC4128ZC devices. |
| | | Improved leakage current specifications for ispMACH 4000Z. For ispMACH 4000V/B/C IIL, IIH condition now includes 0V and 3.6V end points ($0 \leq V_{IN} \leq 3.6V$). |
| | | Added 132-ball chip scale BGA power supply and NC connections. |
| | | Added 132-ball chip scale BGA logic signal connections for LC4064ZC, LC4128ZC and LC4256ZC devices. |
| | | Added lead-free package designators. |
| October 2003 | 18z | Hot socketing characteristics footnote 1. has been enhanced; Insensitive to sequence of VCC or VCCO. However, assumes monotonic rise/fall rates for Vcc and Vcco, provided $(V_{IN} - V_{CCO}) \leq 3.6V$. |
| | | Improved LC4064ZC t _S to 2.5ns, t _{ST} to 2.7ns and f _{MAX} (Ext.) to 175MHz, LC4128ZC t _{CO} to 3.5ns and f _{MAX} (Ext.) to 161MHz (version v.2.1). |
| | | Improved associated internal timing numbers and timing adders (version v.2.1). |
| | | Added ispMACH 4000V/B/C/Z ORP Reference Tables. |
| | | Enhanced ORP information in device pinout tables consistent with the ORP Combinations for I/O Blocks tables (table 6, 7, 8 and 9 in page 9-11). |
| | | Corrected GLB/MC/Pad information in the 256-fpBGA pinouts for the LC4256V/B/C 160-I/O version. |
| | | Added the ispMACH 4000 Family Speed Grade Offering table. |
| | | Added the ispMACH 4128ZC Industrial and Automotive Device OPNs |
| December 2003 | 19z | Added the ispMACH 4032ZC and 4064ZC Industrial and Automotive Device OPNs |